Benchmarq Products 6 from Texas Instruments

bq2954

Lithium Ion Charge Management IC with Integrated Switching Controller

Features

General Description

age and current during charging.

The regulator frequency is set by an

external capacitor for design flexi-

bility. The switch-mode design mini-

For safety, the bq2954 inhibits fast

charging until the battery voltage

and temperature are within config-

ured limits. If the battery voltage is

less than the low-voltage threshold,

the bq2954 provides low-current

For charge qualifiction, the bq2954

uses an external thermistor to mea-

sure battery temperature. Charging begins when power is applied or the

mizes power dissipation.

conditioning of the battery.

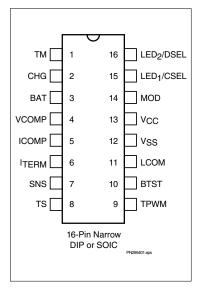
battery is inserted

Pin Names

➤ Safe charge of Li-Ion battery packs

- ► Pulse-width modulation control for current and voltage regulation
- ➤ Programmable high-side/low-side current-sense
- ▶ Fast charge terminated by selectable minimum current; safety backup termination at maximum time
- ► Pre-charge qualification detects shorted or damaged cells and conditions battery
- ► Charging continuously qualified by temperature and voltage limits
- ► Direct LED control outputs to display charge status and fault conditions

Pin Connections



TM	Time-out programming	TPWM	Regulator timebase input
	input	BTST	Battery test output
CHG	Charge active output	LCOM	Common LED output
BAT	Battery voltage input	Vss	System ground
VCOMP	Voltage loop comp input	Vcc	5.0V±10% power
ICOMP	Current loop comp input	MOD	Modulation control
I _{TERM}	Minimum current	MOD	output
	termination select input	LED ₁ /	Charge status output 1/
SNS	Sense resistor input	CSEL	Charge sense select input
TS	Temperature sense input	LED ₂ /	Charge status output 2/
		DSEL	Display select input

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The bq2954 charges a battery in two phases. First a constant-current phase replenishes approximately The bq2954 Li-Ion Charge-Manage-70% of battery capacity. Then a voltment IC uses a flexible pulse-width age-regulation phase completes the modulation regulator to control voltbattery charge.

> The bq2954 provides status indications of all charger states and faults for accurate determination of the battery and charge-system conditions.

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Pin Descriptions

TM Time-out programming input

Sets the maximum charge time. The resistor and capacitor values are determined using Equation 5. Figure 10 shows the resistor/capacitor connection.

CHG Charge active output

An open-drain output is driven low when the battery is removed, during a temperature pend, when a fault condition is present, or when charge is done. CHG can be used to disable a high-value load capacitor to detect quickly any battery removal.

BAT Battery voltage input

Sense input. This potential is generally developed using a high-impedance resistor divider network connected between the positive and the negative terminals of the battery. See Figures 6 and 7 and Equation 1.

VCOMP Voltage loop compensation input

Connects to an external R-C network to stabilize the regulated voltage.

ICOMP Current loop compensation input

Connects to an external R-C network to stabilize the regulated current.

ITERM Charge full and minimum current termination select

Three-state input is used to set I_{FULL} and I_{MIN} for fast charge termination. See Table 4.

SNS Charging current sense input

Battery current is sensed via the voltage developed on this pin by an external sense-resistor.

TS Temperature sense input

Used to monitor battery temperature. An external resistor-divider network sets the lower and upper temperature thresholds. (See Figures 8 and 9 and Equations 3 and 4.)

TPWM Regulation timebase input

Uses an external timing capacitor to ground to set the pulse-width modulation (PWM) frequency. See Equation 7.

BTST Battery test output

Driven high in the absence of a battery in order to provide a potential at the battery terminal when no battery is present.

LCOM Common LED output

Common output for LED₁₋₂. This output is in a high-impedance state during initialization to read programming input on DSEL and CSEL.

VSS Ground

V_{CC} V_{CC} supply

5.0V, ±10%

MOD Current-switching control output

Pulse-width modulated push/pull output used to control the charging current to the battery. MOD switches high to enable current flow and low to inhibit current flow. (The maximum duty cycle is 80%.)

LED₁- Charger display status 1-2 outputs LED₂

Drivers for the direct drive of the LED display. These outputs are tri-stated during initialization so that DSEL and CSEL can be read.

DSEL Display select input (shared pin with LED₂)

Three-level input that controls the $LED_{1\!-\!2}$ charge display modes.

CSEL Charge sense-select input (shared pin with LED₁)

Input that controls whether current is sensed on low side of battery or high side of battery. A current mirror is required for high-side sense.

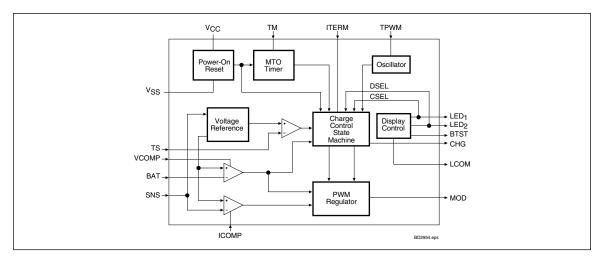


Figure 1. Functional Block Diagram

Functional Description

The bq2954 functional operation is described in terms of the following (Figure 1):

- Charge algorithm
- Charge qualification
- Charge status display
- Configuring the display and termination
- Voltage and current monitoring
- Battery insertion and removal
- Temperature monitoring
- Maximum time--out
- Charge regulation
- Recharge after fast charge

Charge Algorithm

The bq2954 uses a two-phase fast-charge algorithm. In phase 1, the bq2954 regulates constant current until the voltage on the BAT pin, VBAT, rises to the internal threshold, VREG. The bq2954 then transitions to phase 2 and regulates constant voltage (VBAT = VREG) until the charging current falls below the programmed IMIN threshold. Fast charge then terminates, and the bq2954 enters the Charge Complete state. (See Figure 2.)

Charge Qualification

The bq2954 starts a charge cycle when power is applied while a battery is present or when a battery is inserted. Figure 2 shows the state diagram for the bq2954. The bq2954 first checks that the battery temperature is within the allowed, user-configurable range. If the temperature is out of range, the bq2954 remains in the QUALIFICATION state (S01) and waits until the battery temperature and voltage are within the allowed range.

If during any state of charge, a temperature excursion occurs HOT, the bq2954 proceeds to the DONE state (S04) and indicates this state on the LED outputs and provides no current. If this occurs, the bq2954 remains in the DONE state unless the following two conditions are met:

- Temperature falls within valid charge range
- VBAT falls below the internal threshold, VRCHG

If these two conditions are met, a new charge cycle begins. During any state of charge, if a temperature excursion occurs COLD, the bq2954 terminates charge and returns to the QUALIFICATION state (S01). Charge restarts if V_{BAT} and temperature are in valid range.

When the temperature and voltage are valid, the bq2954 enters the CONDITIONING state (S02) and regulates current to I_{COND} (=I_{MAX}/10). After an initial holdoff period t_{HO} (which prevents the IC from reacting to transient voltage spikes that may occur when charge current is first applied), the IC begins monitoring V_{BAT}. If V_{BAT} does not rise to at least V_{MIN} before the expiration of

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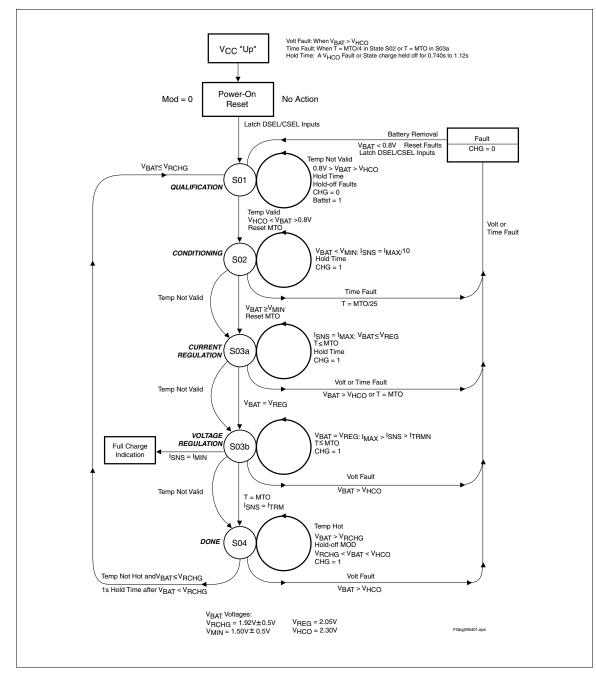


Figure 2. bq2954 Charge Algorithm

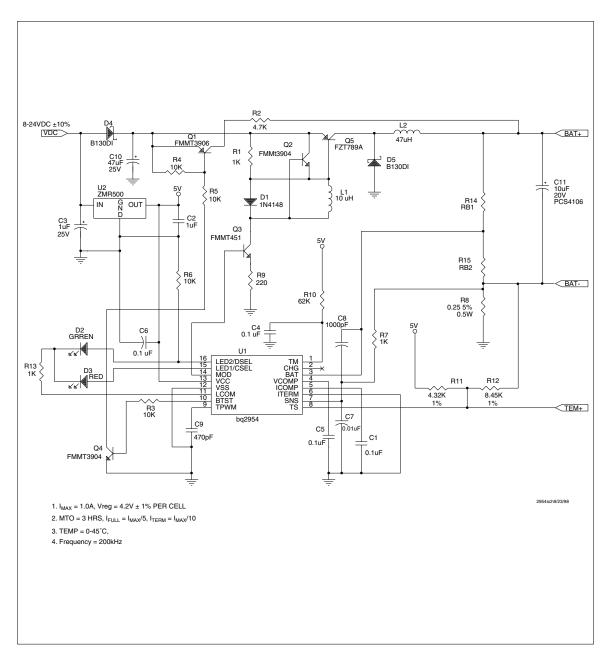


Figure 3. High-Efficiency Li-Ion Charger for 1–4 Cells

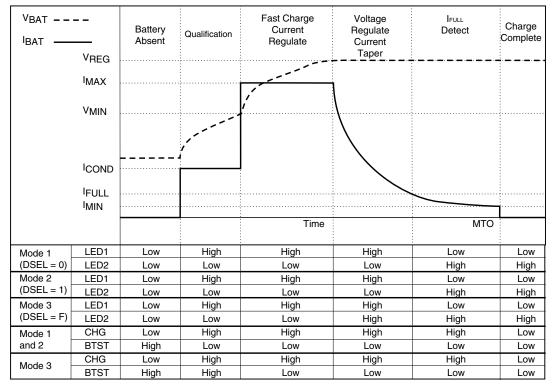


Table 1. Normal Fast Charge Cycle

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time-out limit tqT (i.e., the battery has failed short), the bq2954 enters the Fault state. Then tqT is set to 25% of tMTO. If V_{MIN} is achieved before expiration of the time limit, the bq2954 begins fast charging.

Once in the Fault state, the bq2954 waits until V_{CC} is cycled or a new battery insertion is detected. It then starts a new charge cycle and begins the qualification process again.

Charge Status Display

Charge status is indicated by the LED driver outputs LED₁–LED₂. Three display modes (Tables 1– 3) are available in the bq2954 and are selected by configuring pin DSEL. Table 1 illustrates a normal fast charge cycle, Table 2 a recharge-after-fast-charge cycle, and Table 3 an abnormal condition.

Configuring the Display Mode, I_{FULL}/I_{MIN}, and I_{SENSE}

DSEL/LED₂ and CSEL/LED₁ are bi-directional pins with two functions: as LED driver pins (output) and as programming pins (input). The selection of pull-up, pull-down, or no-resistor programs the display mode on DSEL as shown in Tables 1 through 3. A pull-down or no-resistor programs the current-sense mode on CSEL.

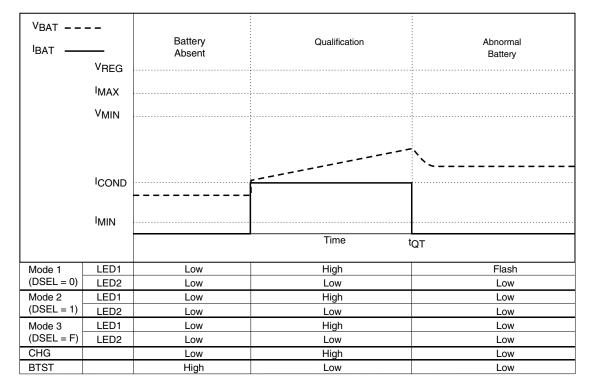
The bq2954 latches the programming data sensed on the DSEL and CSEL input when V_{CC} rises to a valid level. The LEDs go blank for approximately 400ms (typical) while new programming data are latched.

When fast charge reaches a condition where the charging current drops below I_{FULL}, the LED1 and LED2 outputs indicate a full-battery condition. Fast charge terminates when the charging current drops below the

VBAT		Charge Complete	Fast Charge Current Regulate	Voltage Regulate Current Taper	IFULL Detect	Charge Complete
v	VREG I _{MAX} /RECHG	Discharge				
	VMIN					
	ICOND					
	I _{FULL} I _{MIN}				\sim	-
			Time		МТО	
Mode 1	LED1	Low	High	High	Low	Low
(DSEL = 0)	LED2	High	Low	Low	High	High
Mode 2	LED1	Low	High	High	Low	Low
(DSEL = 1)	LED2	High	Low	Low	High	High
Mode 3	LED1	Low	High	High	Low	Low
(DSEL = F)	LED2	High	Low	High	High	High
Mode 1	CHG	Low	High	High	High	Low
and 2	BTST	Low	Low	Low	Low	Low
Mode 3	CHG	Low	High	High	High	Low
WOULD 3	BTST	Low	Low	Low	Low	Low

Table 2. Recharge After Fast Charge Cycle

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Table 4. IFULL and IMIN Thresholds

ITERM	IFULL	IMIN
0	I _{MAX} /5	I _{MAX} /10
1	I _{MAX} /10	I _{MAX} /15
Z	I _{MAX} /15	I _{MAX} /20

minimum current threshold, I_{MIN} . The I_{FULL} and I_{MIN} thresholds are programmed using the I_{TERM} input pin (See Table 4.)

Figures 4 and 5 show the bq2954 configured for display mode 2 and $I_{FULL} = I_{MAX}/5$ while $I_{MIN} = I_{MAX}/10$.

Voltage and Current Monitoring

In low-side current sensing, the bq2954 monitors the battery pack voltage as a differential voltage between BAT and pins. In high-side current sensing, the bq2954 monitors the battery pack voltage as a differential voltage between BAT and V_{SS} pins. This voltage is derived by scaling the battery voltage with a voltage divider. (See Figures 6 and 7.) The resistance of the voltage divider must be high enough to minimize battery drain but low enough to minimize noise susceptibility. RB1 + RB2 is typically between 150k Ω and 1M Ω . The voltage-divider resistors are calculated from the following:

$$\frac{RB1}{RB2} = \frac{N * V_{\text{CELL}}}{V_{\text{REG}}} - 1 \tag{1}$$

where

 $\label{eq:Vcell} \begin{array}{l} V_{CELL} = Manufacturer-specified charging cell voltage \\ N = Number of cells in series \\ V_{REG} = 2.05 V \end{array}$

The current sense resistor, R_{SNS} (see Figures 6 and 7), determines the fast-charge current. The value of R_{SNS} is given by the following:

$$R_{\rm SNS} = \frac{0.25V}{I_{\rm MAX}} \tag{2}$$

where I_{MAX} is the current during the constant-current phase of the charge cycle. (See Table 1.)

Battery Insertion and Removal

VBAT is interpreted by the bq2954 to detect the presence or absence of a battery. The bq2954 determines that a battery is present when VBAT is between the High-Voltage Cutoff (V_{HCO} = V_{REG} + 0.25V) and the Low-Voltage Cutoff ($V_{LCO} = 0.8V$). When V_{BAT} is outside this range, the bq2954 determines that no battery is present and transitions to the battery test state, testing for valid battery voltage. The bq2954 detects battery removal when VBAT falls below VLCO. The BTST pin is driven high during battery test and can activate an external battery contact pull-up. This pull-up may be used to activate an over-discharged Li-Ion battery pack. The VHCO limit implicitly serves as an over-voltage charge fault. The CHG output can be used to disconnect capacitors from the regulation circuitry in order to quickly detect a battery-removed condition.

Battery insertion is detected within 500ms. Transition to the fast-charge phase, however, will not occur for time t_{HO} (approximately one second), even if voltage qualification V_{MIN} is reached. This delay prevents a voltage spike at the BAT input from causing premature entry into the fast-charge phase. It also creates a delay in detection of battery removal if the battery is removed during this hold-off period.

Temperature Monitoring

Temperature is measured as a *differential* voltage between TS and BAT-. This voltage is typically generated by a NTC (negative temperature coefficient) thermistor and thermistor linearization network. The bq2954 compares this voltage to its internal threshold voltages to determine if charging is allowed. These thresholds are the following:

- High-Temperature Cutoff Voltage: V_{TCO} = 0.4 * V_{CC} This voltage corresponds to the maximum temperature (TCO) at which charging is allowed.
- High-Temperature Fault Voltage: V_{HTF} = 0.44 * V_{CC} This voltage corresponds to the temperature (HTF) at which charging resumes after exceeding TCO.
- Low-Temperature Fault Voltage: V_{LTF} = 0.6 * V_{CC} This voltage corresponds to the minimum temperature (LTF) at which charging is allowed.

Charging is inhibited if the temperature is outside the LTF—TCO window. Once the temperature exceeds TCO, it must drop below HTF before charging resumes.

RT1 and RT2 for the thermistor linearization network are determined as follows:

$$0.6 * V_{CC} = \frac{V}{1 + \frac{RT1 * (RT2 + R_{LTF})}{(RT2 * R_{LTF})}}$$
(3)

$$0.44 = \frac{1}{1 + \frac{RT1 * (RT2 + R_{\rm HTF})}{(RT2 * R_{\rm HTF})}} \tag{4}$$

where

RLTF = thermistor resistance at LTF

RHTF = thermistor resistance at HTF

 $V = V_{CC} - 0.250$ in low-side current sensing

 $V = V_{CC}$ in high-side current sensing

TCO is determined by the values of RT1 and RT2. 1% resistors are recommended.

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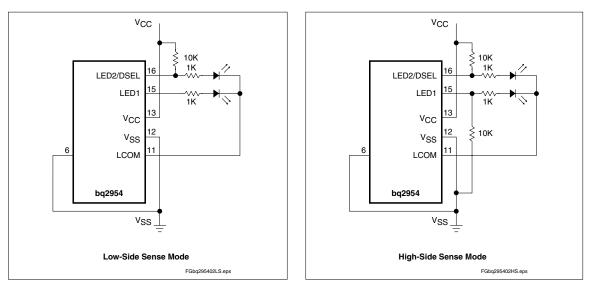


Figure 4. Configured Display Mode (Low-Side Sense)

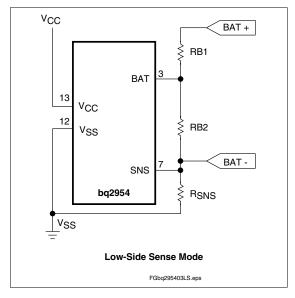


Figure 6. Configuring the Battery Divider (Low-Side Sense)

Figure 5. Configured Display Mode (High-Side Sense)

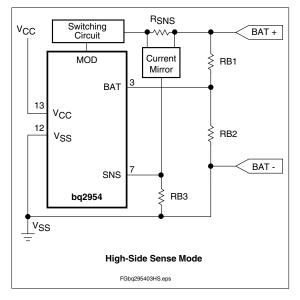


Figure 7. Configuring the Battery Divider (High-Side Sense)

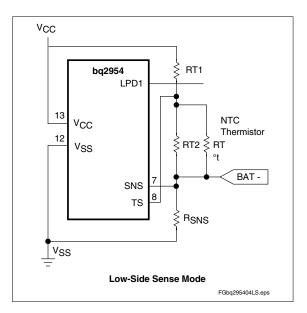


Figure 8. Low-Side Temperature Sensing

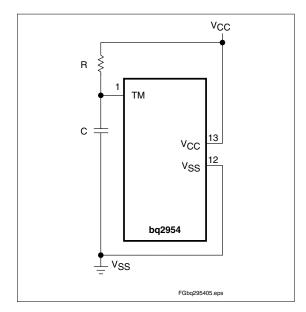


Figure 10. R-C Network/Setting MTO

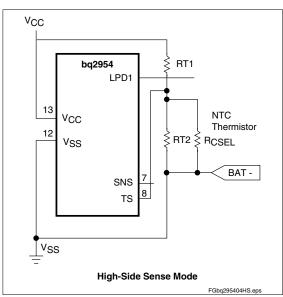


Figure 9. High-Side Temperature Sensing

Disabling Temperature Sensing

Temperature sensing can be disabled by placing a $10k\Omega$ resistor between TS and BAT- and a $10k\Omega$ resistor between TS and V_{CC} . See Figures 8 and 9.

Maximum Time-Out

Maximum Time-Out period (t_{MTO}) is programmed from 1 to 24 hours by an R-C network on the TM pin (see Figure 10) per the following equation:

$$t_{MTO} = 500 * R * C$$
 (5)

where R is in ohms, C is in Farads, and t_{MTO} is in hours. The recommended value for C is $0.1 \mu F.$

The MTO timer is reset at the beginning of fast charge. If the MTO timer expires during the voltage regulation phase, fast charging terminates and the bq2954 enters the Charge Complete state. If the conditioning phase continues for time equal to $t_{\rm QT}$ (MTO/4) and the battery potential does not reach V_{MIN}, the bq2954 enters the fault state and terminates charge. See Table 3. If the MTO timer expires during the current-regulation phase (VBAT never reaches V_{REG}), fast charging is terminated, and the bq2954 enters the fault state.

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Charge Regulation

The bq2954 controls charging through pulse-width modulation of the MOD output pin, supporting both constant-current and constant-voltage regulation. Charge current is monitored at the SNS pin, and charge voltage is monitored at the BAT pin. These voltages are compared to an internal reference, and the MOD output is modulated to maintain the desired value. The maximum duty cycle is 80%.

Voltage at the SNS pin is determined by the value of resistor R_{SNS} , so nominal regulated current is set by the following equation:

$$I_{MAX} = V_{SNS} / R_{SNS}$$
 (6)

The switching frequency of the MOD output is determined by an external capacitor (CPWM) between the pin TPWM and VSS pins, per the following:

$$f_{PWM} = \frac{1 * 10^{-4}}{C_{PWM}}$$
(7)

Where C is in Farads and the frequency is in Hz. A typical switching rate is 100 kHz, implying CPWM = 0.001μ F. MOD pulse width is modulated between 0 and 80% of the switching period.

To prevent oscillation in the voltage and current control loops, frequency compensation networks (C and R-C respectively) are typically required on the VCOMP and ICOMP pins .

Recharge After Fast Charge

Once charge completion occurs, a fast charge is initiated when the battery voltage falls below V_{RECHG} threshold. A delay of approximately one second passes before recharge begins so that adequate time is allowed to detect battery removal. (See Table 1.)

Symbol	Parameter	Minimum	Maximum	Unit	Notes
V _{CC}	V _{CC} relative to V _{SS}	-0.3	+7.0	v	
VT	DC voltage applied on any pin excluding V _{CC} relative to V _{SS}	-0.3	+7.0	v	
m		-20	+70	°C	Commercial
TOPR	Operating ambient temperature	-40	+85	°C	Industrial "N"
T _{STG}	Storage temperature	-55	+125	°C	
TSOLDER	Soldering temperature	-	+260	°C	10s max.

Absolute Maximum Ratings

Note: Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

DC Thresholds (TA = TOPR; VCC = 5V $\pm 10\%$)

Symbol	Parameter	Rating	Unit	Tolerance	Notes
VREG	Internal reference voltage	2.05	v	1%	$TA = 25^{\circ}C$
	Temperature coefficient	-0.5	mV/°C	10%	
VLTF	TS maximum threshold	0.6 * VCC	v	$\pm 0.03 V$	Low-temperature fault
V _{HTF}	TS hysteresis threshold	$0.44 * V_{CC}$	v	$\pm 0.03 V$	High-temperature fault
VTCO	TS minimum threshold	0.4 * VCC	v	$\pm 0.03 V$	Temperature cutoff
V _{HCO}	High cutoff voltage	V_{REG} + 0.25V	v	$\pm 0.03 V$	
V _{MIN}	Under-voltage threshold at BAT	1.5	v	$\pm 0.05 V$	
VRECHG	Recharge voltage threshold at BAT	1.92	v	$\pm 0.05 V$	
V _{LCO}	Low cutoff voltage	0.8	v	$\pm 0.03 V$	
X 7		0.250	v	10%	I _{MAX}
V _{SNS}	Current sense at SNS	0.025	v	10%	ICOND

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Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
V _{CC}	Supply voltage	4.5	5.0	5.5	V	
VTEMP	TS voltage potential	0	-	VCC	v	VTS - VSNS
VBAT	BAT voltage potential	0	-	VCC	v	
ICC	Supply current	-	2	4	mA	Outputs unloaded
	DSEL tri-state open detection	-2	-	2	μA	Note
I_{IZ}	I _{TERM} tri-state open detection	-2		2	μA	
V_{IH}	Logic input high	V _{CC} - 0.3	-	-	v	DSEL, I _{TERM}
VIL	Logic input low	-	-	$V_{SS} + 0.3$	v	DSEL, CSEL, I _{TERM}
	LED1, LED2, BTST, output high	VCC - 0.8	-	-	v	$I_{OH} \leq 10 mA$
VOH	MOD output high	VCC - 0.8	-	-	v	$I_{OH} \leq 10 mA$
	LED1, LED2, BTST, output low	-	-	VSS +0.8	v	$I_{OL} \leq 10 mA$
	MOD output low	-	-	$V_{SS} + 0.8$	v	$I_{OL} \leq 10 mA$
VOL	CHG output low	-	-	$V_{SS} + 0.8$	v	$I_{OL} \le 5mA$, Note 3
	LCOM output low	-	-	$V_{SS} + 0.5$	v	$I_{OL} \leq 30 mA$
	LED ₁ , LED ₂ , BTST, source	-10	-	-	mA	$V_{OH} = V_{CC} - 0.5V$
Іон	MOD source	-5.0	-	-	mA	VOH =VCC - 0.5V
	LED ₁ , LED ₂ , BTST, sink	10	-	-	mA	$V_{OL} = V_{SS} + 0.5V$
	MOD sink	5	-	-	mA	$V_{OL} = V_{SS} + 0.8V$
IOL	CHG sink	5	-	-	mA	V _{OL} = V _{SS} + 0.8V, Note 3
	LCOM sink	30	-	-	mA	$V_{OL} = V_{SS} + 0.5 V$
Tee	DSEL logic input low source	-	-	+30	μA	V = V _{SS} to V _{SS} + 0.3V, Note 2
IIL	ITERM logic input low source	-	-	+70	μA	V = $V_{\rm SS}$ to $V_{\rm SS}$ + 0.3V
Teres	DSEL logic input high source	-30	-	-	μA	V = $V_{\rm CC}$ - 0.3V to $V_{\rm CC}$
I _{IH}	ITERM logic input high source	-70	-	-	μA	$V = V_{CC} - 0.3V$ to V_{CC}

Recommended DC Operating Conditions (TA = TOPR)

Notes: 1. All voltages relative to VSS.

 $2. \quad Conditions \ during \ initialization \ after \ V_{CC} \ applied.$

3. SNS = 0V.

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
R _{BATZ}	BAT pin input impedance	50	-	-	MΩ	
R _{SNSZ}	SNS pin input impedance	50	-	-	MΩ	
R _{TSZ}	TS pin input impedance	50	-	-	MΩ	
R _{PROG1}	Soft-programmed pull-up or pull-down resistor value (for programming)	-	-	10	kΩ	DSEL, CSEL
RPROG2	Pull-up or pull-down resistor value	-	-	3	kΩ	ITERM
R _{MTO}	Charge timer resistor	20	-	480	kΩ	

Impedance (T_A = T_{OPR}; V_{CC} = 5V \pm 10%)

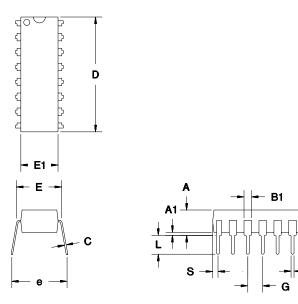
Timing (TA = TOPR; VCC = 5V \pm 10%)

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
t _{MTO}	Charge time-out range	1	-	24	hours	See Figure 10
tQT	Pre-charge qual test time-out period	-	0.25 * tmto	-	-	
$t_{\rm HO}$	Pre-charge qual test hold-off period	300	600	900	ms	
fPWM	PWM regulator frequency range	-	100	200	kHz	See Equation 7
dPWM	Duty cycle	0	-	80	%	

Capacitance

Symbol	Parameter	Minimum	Typical	Maximum	Unit
Смто	Charge timer capacitor	-	-	0.1	μF
CPWM	PWM capacitor	-	0.001	-	μF

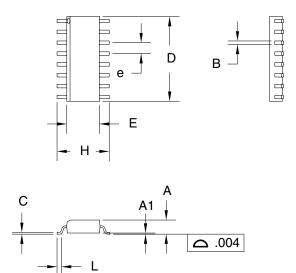
16-Pin DIP Narrow (PN)



16-Pin PN (0.300" DIP)

	Inc	hes	Millimeters		
Dimension	Min.	Max.	Min.	Max.	
Α	0.160	0.180	4.06	4.57	
A1	0.015	0.040	0.38	1.02	
В	0.015	0.022	0.38	0.56	
B1	0.055	0.065	1.40	1.65	
С	0.008	0.013	0.20	0.33	
D	0.740	0.770	18.80	19.56	
Е	0.300	0.325	7.62	8.26	
E1	0.230	0.280	5.84	7.11	
е	0.300	0.370	7.62	9.40	
G	0.090	0.110	2.29	2.79	
L	0.115	0.150	2.92	3.81	
S	0.020	0.040	0.51	1.02	

16-Pin SOIC Narrow (SN)



16-Pin SN (0.150" SOIC)

	Inc	Inches		neters
Dimension	Min.	Max.	Min.	Max.
Α	0.060	0.070	1.52	1.78
A1	0.004	0.010	0.10	0.25
В	0.013	0.020	0.33	0.51
С	0.007	0.010	0.18	0.25
D	0.385	0.400	9.78	10.16
Е	0.150	0.160	3.81	4.06
е	0.045	0.055	1.14	1.40
Н	0.225	0.245	5.72	6.22
L	0.015	0.035	0.38	0.89

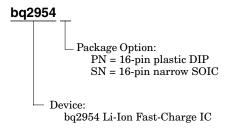
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Data Sheet Revision History

Change N	Io. Page No.	Description of Change
1	All	"Final" changes from "Preliminary" version

Note: Change 1 = Oct. 1998 B changes from Nov. 1997 "Preliminary."

Ordering Information



IMPORTANT NOTICE

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
							(6)				
BQ2954PN	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	2954PN-A3	Samples
BQ2954SN	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	2954 -A3	Samples
BQ2954SNTR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	2954 -A3	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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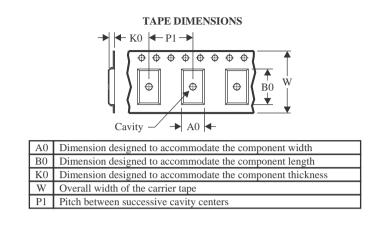


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
BQ2954SNTR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
BQ2954SNTR	SOIC	D	16	2500	356.0	356.0	35.0

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
BQ2954PN	N	PDIP	16	25	506	13.97	11230	4.32
BQ2954SN	D	SOIC	16	40	506.6	8	3940	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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